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<th>Number</th>
<th>Quantity</th>
<th>Part Number</th>
<th>Description</th>
<th>Freq Type</th>
<th>Draw Size</th>
<th>Scale</th>
<th>Name</th>
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<tbody>
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<td>12345</td>
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<td>234</td>
<td>PAC2</td>
</tr>
</tbody>
</table>

**Diagram**

[Diagram image]

**Legend**

- **Num**: Number
- **Qty**: Quantity
- **P/N**: Part Number
- **Desc**: Description
- **Freq Type**: Frequency Type
- **Draw Size**: Draw Size
- **Scale**: Scale
- **Name**: Name

**Notes**

- All numbers viewed from the top side.
- Board 1: PH0001
- Rev A
- SVN Rev not in VersionControl

**Layer Name**: Drill Drawing

**Plot Name**: Drill Drawing

**Generated**: 7/2/2017

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